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FORM PTO-1449 (Modified)

ATTY. DOCKET NO.  
6136/53755 (25916-111)SERIAL NO.  
UnassignedLIST OF PATENTS AND PUBLICATIONS FOR  
APPLICANT(S)' INFORMATION DISCLOSURE  
STATEMENT

(Use several sheets if necessary)

APPLICANT Solomon I. Beilin, et al.

FILING DATE  
Filed HerewithGROUP ART UNIT  
Unassigned

## REFERENCE DESIGNATION

## U.S. PATENT DOCUMENTS

EXAM'R INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	Subclass	Filing Date If Appropriate
SA	A1	4,181,755	1/1/80	Liu, et al.	430	314	
	A2	4,307,179	12/22/81	Chang, et al.	430	314	
	A3	4,622,058	11/11/86	Leary-Renick, et al.	65	105	
	A4	4,634,496	1/6/87	Mase, et al.	156	643	
	A5	4,795,722	1/3/89	Welch, et al.	437	192	
	A6	4,824,521	4/25/89	Kulkarni, et al.	156	643	
	A7	4,954,142	9/4/90	Carr, et al.	51	309	
	A8	4,981,553	1/1/91	Tytgat, et al.	156	666	
	A9	5,006,485	4/9/91	Villalon	437	195	
	A10	5,084,071	1/28/92	Nenadic, et al.	51	309	
	A11	5,091,339	2/25/92	Carey	437	187	
	A12	5,098,517	3/24/92	Tytgat, et al.	156	666	
	A13	5,118,385	6/2/92	Kumar, et al.	156	644	
	A14	5,137,597	8/11/92	Curry, II, et al.	156	636	
	A15	5,162,260	11/10/92	Leibovitz, et al.	437	195	
	A16	5,169,491	12/8/92	Doan	156	636	
	A17	5,217,586	6/8/93	Datta, et al.	204	129.6	
	A18	5,219,793	6/15/93	Cooper, et al.	437	195	
	A19	5,225,034	7/6/93	Yu, et al.	156	636	
✓	A20	5,244,534	9/14/93	Yu, et al.	156	636	
SA	A21	5,246,884	9/21/93	Jaso, et al.	437	225	

EXAMINER

Shamim Ahmed

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EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	Subclass	Filing Date If Appropriate
S A	A22	5,258,096	11/2/93	Sandhu, et al.	156	643	
	A23	5,272,117	12/21/93	Roth, et al.	437	228	
					156	630	
	A25	5,287,619	2/22/94	Smith, et al.	29	852	
	A26	5,298,463	3/29/94	Sandhu, et al.	437	192	
	A27	5,302,551	4/12/94	Iranmanesh, et al.	437	195	
	A28	5,314,843	5/24/94	Yu, et al.	437	225	
	A29	5,328,553	7/12/94	Poon	156	636	
	A30	5,332,467	7/26/94	Sune, et al.	156	636	
	A31	5,350,712	9/27/94	Shibata	437	195	
	A32	5,354,490	10/11/94	Yu, et al.	252	79.1	
	A33	5,354,712	10/11/94	Ho, et al.	437	195	
	A34	5,363,550	11/15/94	Aitken, et al.	29	828	
	A35	5,380,546	1/10/95	Krishnan, et al.	427	126.1	
	A36	5,389,194	2/14/95	Rostoker, et al.	156	636	
	A37	5,397,741	3/14/95	O'Connor, et al.	437	187	
	A38	5,429,987	7/4/95	Allen	437	187	
	A39	5,451,543	9/19/95	Woo, et al.	437	195	
↓	A40	5,451,551	9/19/95	Krishnan, et al.	437	241	
S A	A41	5,453,402	9/26/95	Cheung, et al.	437	195	

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**FOREIGN PATENT DOCUMENTS**

EXAM'R INITIAL		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	Subclass	TRANSLATN	
							yes	no
	B1							

**OTHER ART (Include Author, Title, Date, Pertinent Pages, Etc.)**

SA	C1	Andrew R. Fee, et al., "Rockwell Hardness Testing," <i>ASM Handbook</i> , Vol. 8, Mechanical Testing, The Materials Information Society, pgs. 74-83, 109-113. <i>Nov, 1989</i>
	C2	T.A. Shankoff, et al., "High Resolution Tungsten Patterning Using Buffered, Mildly Basic Etching Solutions," <i>J. Electrochem. Soc.: SOLID STATE SCIENCE AND TECHNOLOGY</i> , Feb., 1975, pgs. 297-298.
	C3	<i>Materials Handbook for Hybrid Microelectronics</i> , Teledyne Microelectronics, Los Angeles, CA 1988, pg. 476.
	C4	<i>Goodfellow Metals and Materials for Research and Industry</i> , Catalog, 1992-1993, 6 pgs.
	C5	<i>Handbook of Plastics, Elastomers, and Composites</i> , Second Edition, Technology Seminars, Inc., Lutherville, Maryland, 1992, 4 pages.
↓	C6	Second Edition, <i>CRC Materials Science and Engineering Handbook</i> , CRC Press, 1994, 3 pgs.
SA	C7	<i>Semiconductor International</i> , "CMP: Suppliers Integrating, Applications Spreading," Nov. 1995, pgs. 74-82.

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